

# ISCAS 2024

Singapore | May 19-22, 2024  
Resorts World Sentosa Convention Centre

## Call for Live Demonstrations



The IEEE International Symposium on Circuits and Systems (ISCAS) is the flagship conference of the IEEE Circuits and Systems Society and the world's premier forum for researchers in the active fields of theory, design and implementation of circuits and systems. ISCAS 2024 will be held in Singapore, from May 19 to 22, 2024. The IEEE ISCAS 2024 Organizing Committee invites proposals for Live Demonstrations to be held during ISCAS 2024. The live demonstrations will be carried out in presentation booths with ample space to set up a working system, whether it is an interactive software on a laptop, a hardware setup, or a system acquiring signals from a human. Conference attendees are invited to experience the demonstrations directly, to interact with, play with, and challenge them. A panel of judges will select the three Best Demos presented during the Symposium on the basis of creativity, innovation, and visitor experience. These Demos will be awarded with \$500, \$300 and \$200, respectively.

Authors are invited to submit a one-page demo description using the same page formatting as for regular ISCAS papers. The one-page demo description can be based on either already published paper as a demo for the first time or new paper submitted to ISCAS 2024. During submission of the one-page demo description, authors should select "Live Demonstrations" as the Primary Track and an appropriate topical subtrack as the Secondary Track.

### One-page Demo Description

The one-page demo description must contain the following information:

- Demonstration Title and Reference:** The demonstration title must begin with "Live Demonstration:". If the one-page demo description is based on already published paper, please include at least one reference to your published paper about the scientific background of your live demonstration, and this will not be considered as violation to double-blind review policy. The reference must be easily accessible for the reviewers, a URL is highly recommended! If the one-page demo description is based on new paper submitted to ISCAS 2024, please include the submission ID of your ISCAS paper in the demo description.
- Demonstration Setup:** Describe the equipments you will bring to ISCAS 2024. Include a photograph and/or screenshot. Only a power plug, a table and display stand will be provided. Demonstrators are responsible for the transportation of their own equipment to the meeting site. Indicate any special requirements such as extra space for demonstrating robotic movement or other requirements which the organisers should be aware of.
- Visitor Experience:** Explain the way in which a visitor experiences and interacts with your demonstration, how it reveals the essence of your work, furthers understanding, and what the visitor will learn.
- Optional Video:** For the initial submission only, authors can also include an optional link to a video (max 5min) about their demo. This video is only meant to facilitate the review process, and does not substitute for the live demo.

### Important Dates:

Demo Description Submission:  
Authors' Decision Notification:

Nov 7, 2023 (extended)  
Jan 15, 2024



2024.ieee-iscas.org

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